Application No. New U.S. National Stage of PCT/GB2003/005210

JC17 Rec'd PCI/PTO 24 JUN 2005

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Original) A rare earth transition metal (RE-TM) alloy structure comprising a RE-TM alloy substrate and a noble metal diffusion barrier disposed thereon, therein the RE-TM alloy is a magnetic alloy in which the rare earth element is samarium and the noble metal diffusion barrier comprises platinum metal.
- 2. (Original) A structure according to claim 1, wherein the RE-TM alloy is a Sm-Co-Cu-Fe-Zr magnetic alloy.
- 3. (Currently Amended) A structure according to claim 1 or elaim 2, wherein the noble metal layer is in direct contact with the alloy substrate on one side, the opposite side being exposed to the exterior environment.
- 4. (Currently Amended) A structure according to any preceding claim 1, which is a permanent magnet article.
- 5. (Original) A permanent magnet article of claim 4 which is an aerospace component.
- 6. (Currently Amended) A method of forming a structure according to any preceding claim 1, wherein the noble metal diffusion barrier is formed by electroplating.

- 7. (Original) A method of reducing rare earth metal depletion at the surface of a RE-TM permanent magnet, which method comprises providing over the surface a noble metal diffusion barrier.
- 8. (Original) A method according to claim 7, wherein the RE-TM permanent magnet is a SM-TM high temperature permanent magnet.
- 9. (New) A structure according to claim 2, wherein the noble metal layer is in direct contact with the alloy substrate on one side, the opposite side being exposed to the exterior environment.
 - 10. (New) A structure according to claim 2, which is a permanent magnet article.
 - 11. (New) A structure according to claim 3, which is a permanent magnet article.
- 12. (New) A method of forming a structure according to claim 2, wherein the noble metal diffusion barrier is formed by electroplating.
- 13. (New) A method of forming a structure according to claim 3, wherein the noble metal diffusion barrier is formed by electroplating.
- 14. (New) A method of forming a structure according to claim 4, wherein the noble metal diffusion barrier is formed by electroplating.

15. (New) A method of forming a structure according to claim 5, wherein the noble
metal diffusion barrier is formed by electroplating.